# **UNHS203**

# Circuit Protector Elements

## For overcurrent protection

### ■ Features

- Sharp cutoff characteristics and low voltage drop
- Flame retardant package and low heat generation, high density mounting is possible.

### ■ Absolute Maximum Ratings $T_a = 25$ °C

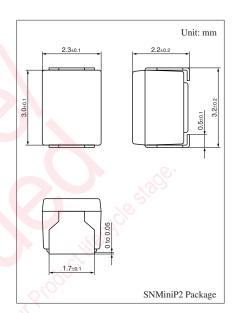
Parameter	Symbol	Rating	Unit	
Operating ambient temperature	T <sub>opr</sub>	-55 to +125	°C	
Storage temperature	$T_{stg}$	-55 to +125	°C	

# ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Min	Тур	Max	Unit
Rated voltage		50		V
Rated current		1.2		A
Internal Resistance	34	45	56	mΩ
Cutoff current *		2.4	\ C	S A

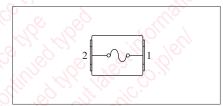
Note) \*: Measurement condition of cutoff current shall be at T<sub>a</sub>=25°C, t=1 s

Tolerance of cutoff current shall be ± 20%



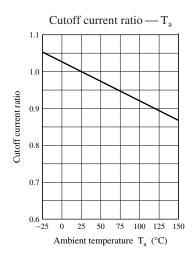
Marking Symbol: 1.2

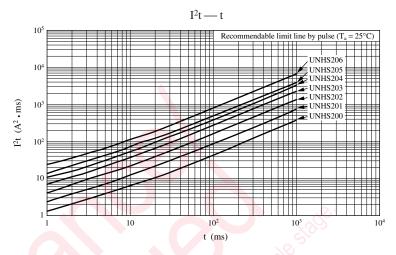
### Lead Connection

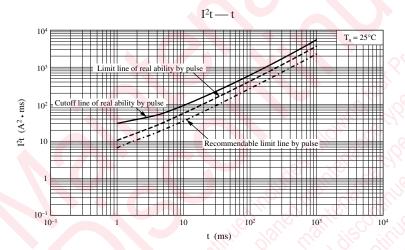


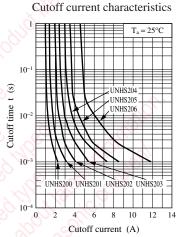
## ■ Usage Notes

- Package shall be overheated and dangerous for overcurrent.
- This device should be used only to the secondary circuit. Package will be damaged for added overpower.
- This device is not electrical fuse legally. Please draw a clear line between electrical fuse from this device.

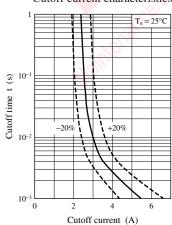








### Cutoff current characteristics



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